



Micropattern Gas Detectors

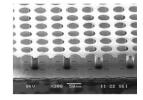
J. Kaminski Universität Bonn

Vertex 2008, Utö, Sweden







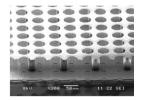


Contents



- Short Overview over (Micropattern) Gas Detectors MPGDs
- Micromegas (MM) & Gas Electron Multipliers (GEMs)
 - New Developments and Applications of MPGDs
 - CMOS Pixel Readout of GEMs and MMs
 - **GOSSIP**





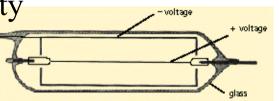
History of Gaseous Detectors



1908: First wire Counter

used by Ruherford in the Study of natural radioactivity

E. Rutherford and H. Geiger, Proc. Royal Soc. A81 (1908) 141

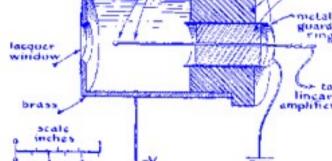


1928: Geiger-Müller Counter - single Electron sensitivity

H. Geiger and W. Müller, Phys. Zeits. 29 (1928) 839

1945: Proportional tubes (+)

ma (+) (+)



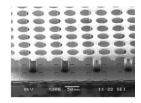
1967: Multi-wire Proportional chambers

G. Charpak, Proc. Int. Symp. Nuclear Electronics (Versailles 10-13 Sept 1968)

1974 Time Projection Chambers

D. R. Nygren, LBL Internal Report (Feb. 1974)

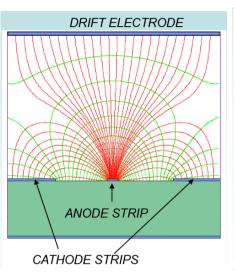


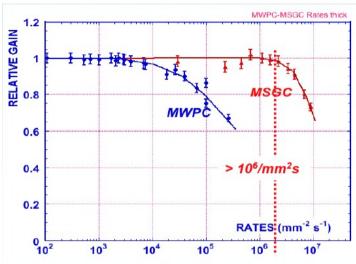


Historic Overview MPGD



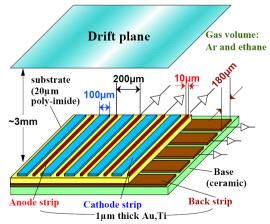
In 1988 A. Oed introduced the age of micro pattern gas detectors.

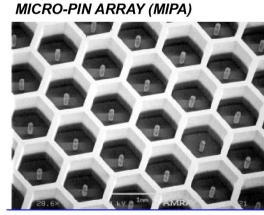


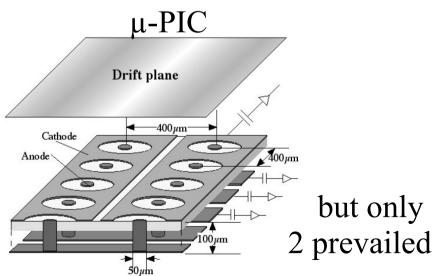




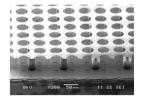
Many new geometries were tested, ...









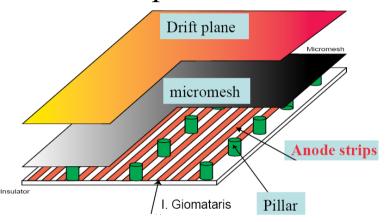


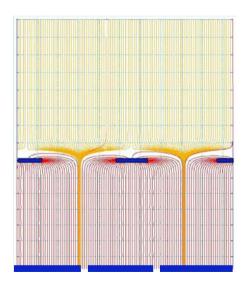
The 2 Favorites:



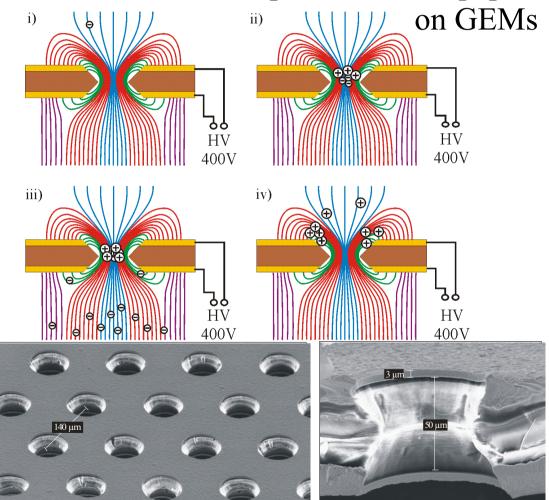
Micromegas & GEMs

1996 first publication of MM

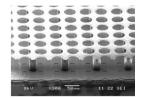




1997 F. Sauli publishes first paper







Micromegas



Bulk-Micromegas

Base Material

Copper Plane
FR4

Lamination of Vacrel

Mesh

Positioning of Mesh

Encapsulation of Mesh

Contact to anode plane

Spacers

Development of Contacts and Spacers

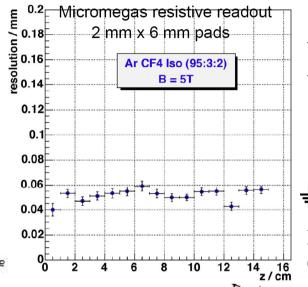
Contact to Mesh

Bulk Micromegas obtained by lamination of a woven grid on an anode with a photo-imageable film

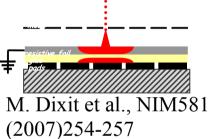
large area and robustness easy implementation low cost T2 industrial process abo

B= 5 T D_T= 19 μm/√cm

M. Dixit et al., NIM581(2007)254-257

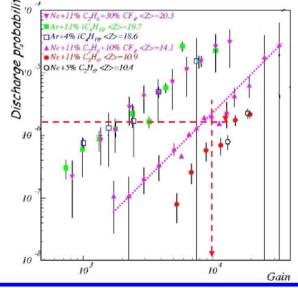


Cover readout pads with resistive foil to broaden signal shape



discharge probability at COMPASS tracker:

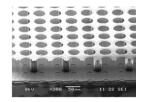
 $\sim 10^{-6}$



T2K Micromegas TPC:

about 12 m² detector surface

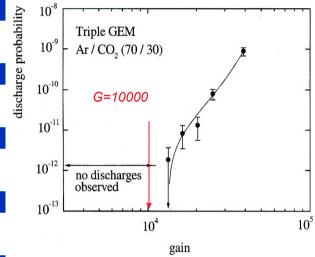




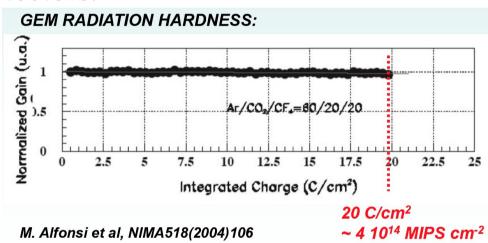
GEMs



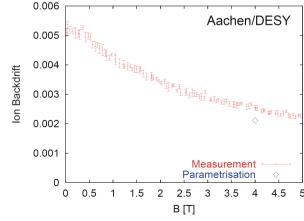
A large number of experiments have lead to a fair understanding of the enormous parameter space in GEM-detectors.



discharge probability at COMPASS tracker: <10⁻¹²



low ion backflow



There are many modifications e.g. the RETGEMs

High resistivity layer

Holes

Figure 1

Dielectric

Fully spark protected detector

geom. and elec. characteristics: 0.3-0.8 mm, pitch 0.7- 1.2 mm,

thickness 0.5-2 mm.

Resistivity:200-800k Ω /cm

Kapton type: 100XC10E





Advantages of MPGD



- ion backflow can be reduced significantly
 - => continuous readout is possible
- small pitch of gas amplification regions (i.e. holes)
 - => strong reduction of ExB-effects
- no preference in direction (as with wires)
 - => all 2 dim. readout geometries can be used
- no ion tail => very fast signal (O(10ns))
 - => good timing and double track resolution
- no induced signal, but direct e-collection
 - => small transverse width
 - => good double track resolution

Applications in thin tracking devices - e.g. COMPASS photon detection - e.g. CAST, Weizmann Institute large volume drift chambers - e.g. TPC





COMPASS Upgrade



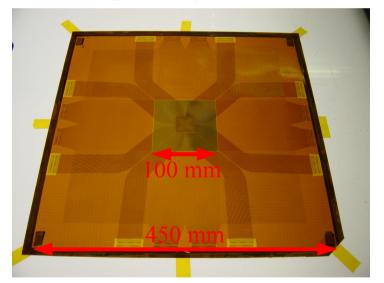


COmmon Muon and Proton Apparatus for Structure and Spectroscopy

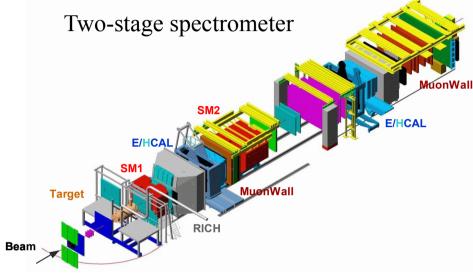
Plans to upgrade the detector for 2008

beam tracking with GEM detectors:

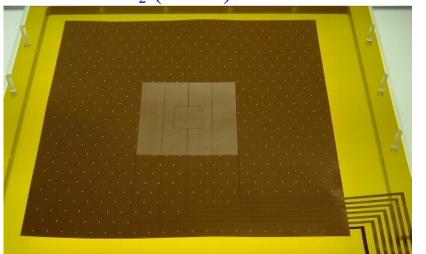
- GEM material budget 0.4% X₀
- beam rate $2*10^7$ s⁻¹
- rate capability $> 10^5 \text{ mm}^{-2}\text{s}^{-1}$



- 3-layer PCB, 100mm APICAL®
- center: 32×32 pixels, 1 mm²
- periphery: 2×512 strips (2D)



Gas: Ar/CO₂ (70/30)



discharge prevention:

- · triple GEM
- · asymmetric gain sharing
- · segmented GEM foils





COMPASS Beam Test Results



- beam test at CERN
- 160 GeV/c muons intensity 4.2·10⁷/s
 - up to $1.2 \cdot 10^5 / \text{mm}^2 / \text{s}$
- 190 GeV/c π intensity $10^6/s$
- up to $1.2 \cdot 10^4 / \text{mm}^2 / \text{s}$

spatial resolution:

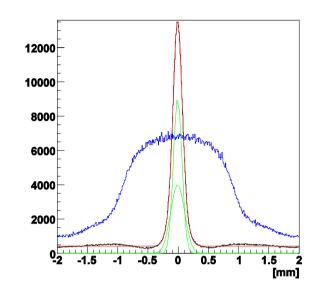
low intensity $(4*10^6 \mu/s)$:

90µm

high intensity $(5*10^7 \mu/s)$:

135µm

efficiency: 96% -98.5%



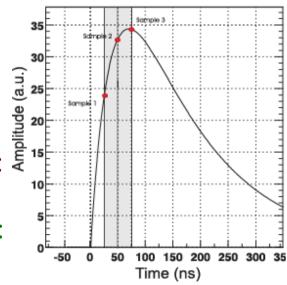
- time residuals:
 - 3 samples of rising edge
- t₀ reconstructed from known pulse shape

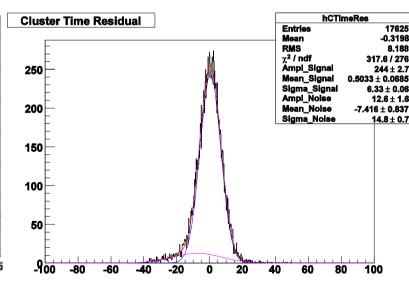
low intensity $(4*10^6 \, \mu/s)$:

6.3 ns

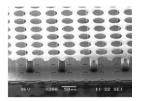
high intensity $(5*10^7 \mu/s)$:

7.3 ns



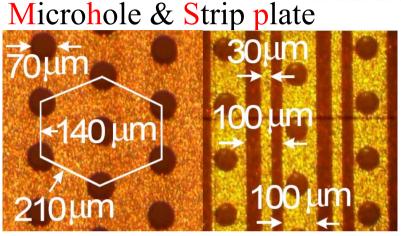


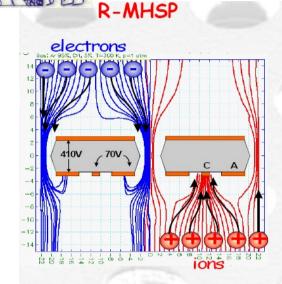


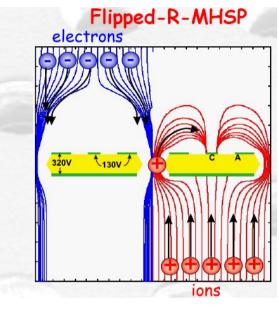


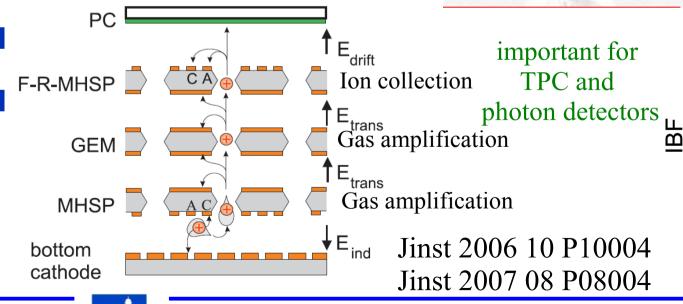
Reduction of Ion Backflow

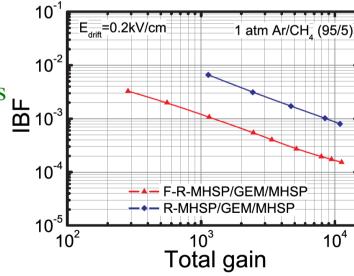




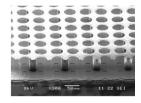








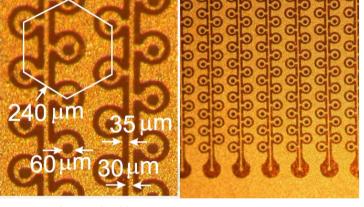


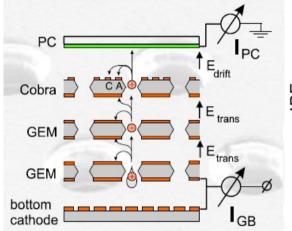


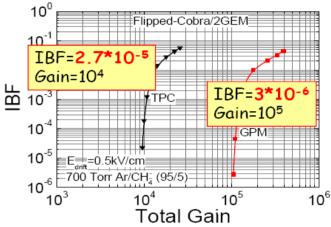
More on Reduction of Ion Backflow WEIZMANN INSTITUTE OF SCIENCE



COBRA

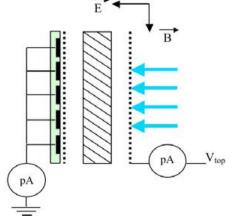


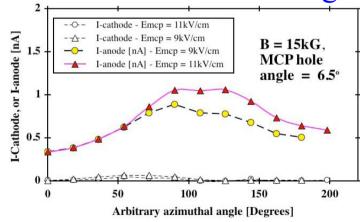




- Ion backflow = 0.0027% electron collection efficiency
- electron collection efficiency is only 20 %

Microchannel Plates with inclined holes in magnetic fields

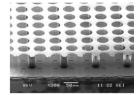




Lorentz-angle is used to neutralize ions

J. Va'vra, T. Sumiyoshi, NIM A 553 (2005) 76-84

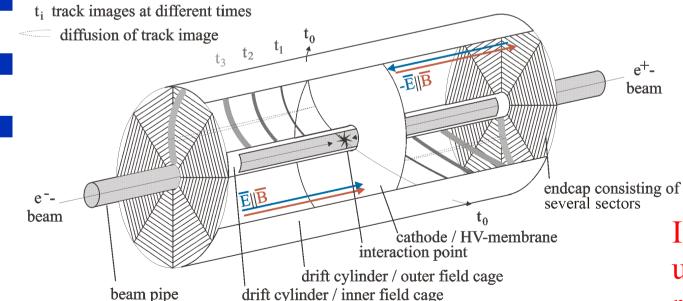




TPC with MPGDs



- good spatial resolution (O(100μm))
 - large number of measurements (200)
- good energy resolution with dE/dx (5%)
 - true 3-dimensional detector (no ambiguities)
- high granularity (10⁹ voxels)
 - low material budget (3%X₀)
- very homogeneous (only gas)
 - comparably cheap



Large number of experiments are designing and constructing TPCs with MPGD:

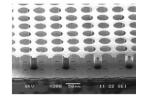
GEM: FOPI, PANDA, Crystal Barrel, ILC, MICE MM: T2K, ILC

Disadvantages:

- long drift times (40µs)
- ions have to be neutralized after gas amplification
- diffusion and pad size limits spatial resolution

Improve spatial resolution: use 'naked' CMOS pixel readout chip as anode

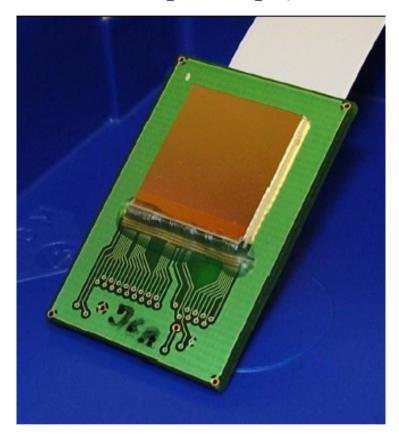




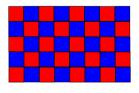
TimePix



Timepix chip (1st version) derived from MediPix-2



current running condition: checker-board pattern of TOT and Time



Available for detector tests since Nov. 2006

256 * 256 Pixel

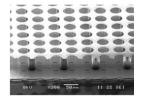
Pixel size: $55 * 55 \mu m^2$

chip dimensions: 1.4 * 1.4 cm²

Each pixel can be set to one of these modes:

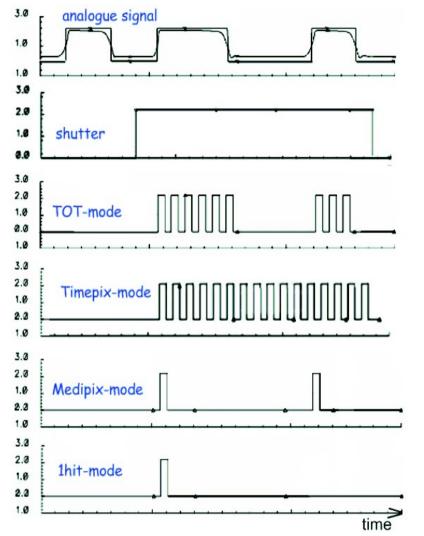
- Hit counting
- TOT = time over threshold gives integrated charge
- Time between hit and shutter end
- Hit/no-Hit





TimePix working principle





output of analogue circuit

shutter: activates digital readout

time-over-threshold: charge measurement => integrates over all hits

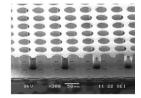
time-mode: measures time from first hit to end of shutter

MediPix-mode: number of hits

1-hit mode: hit/no hit

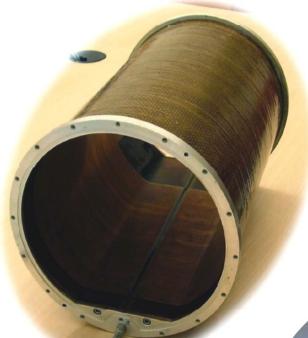
Disadvantage: not multi-hit capable





Test Detector at Bonn





Field cage designed and produced at Aachen

drift distance: 26 cm

inner diameter: 23 cm

double layer field cage with ~200 field strips

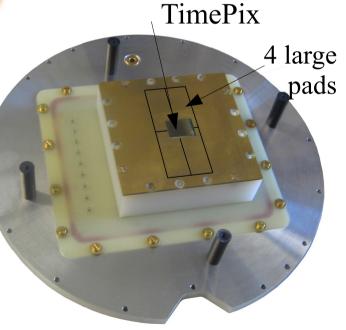
material budget: 1 % X₀

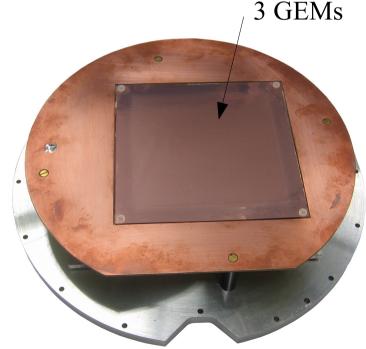
up to $30 \text{ kV} \Rightarrow \text{drift field of } 1 \text{ kV/cm}$

For now:

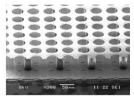
Ar: CO₂ 70:30

E_{drift}: 500 V/cm



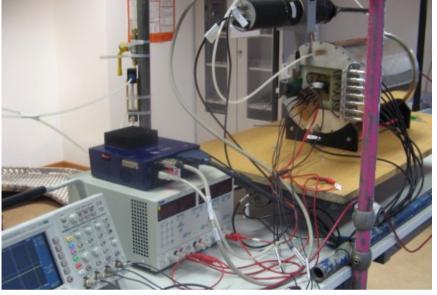






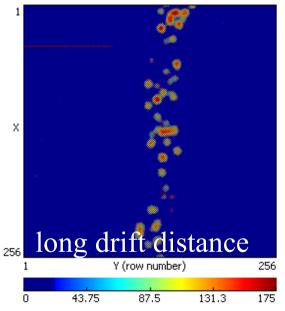
Cosmic Ray Setup

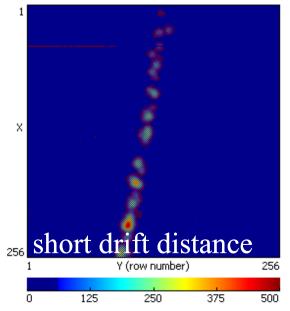


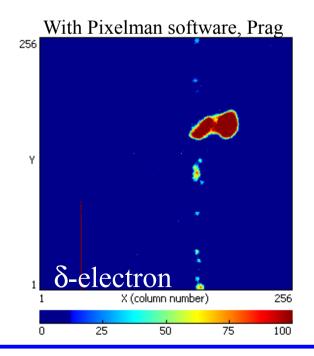


coincidence of 2 scintillators (2 * 23 cm², 4.5* 35 cm²) gives external start signal

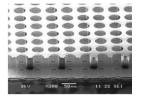
=> 40,000 tracks collected







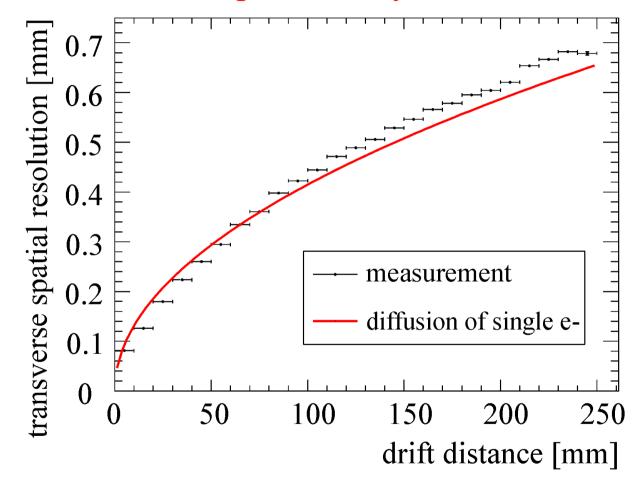








preliminary!

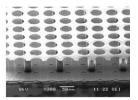


diffusion of single e^{-} : $\sigma = D_{T}^{*} \sqrt{x}$

note: $n_{eff} = 1$

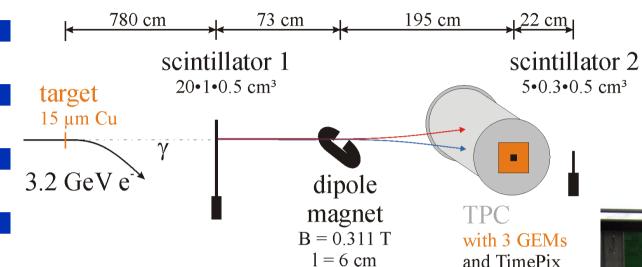
Only selection criteria: tracks with more than 5 hits





Test Beam Setup





beam profile in y-direction

100
90
40

Chip position

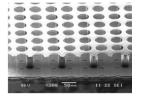
chip position

y-position scintillator 2 / mm

- γ were created at a target
- primary e-beam was dumped
- photons converted in scintillator 1
- dipole separated e⁺e⁻
- Coincidence of scinti 1 and 2 select single particle events

begin of this month



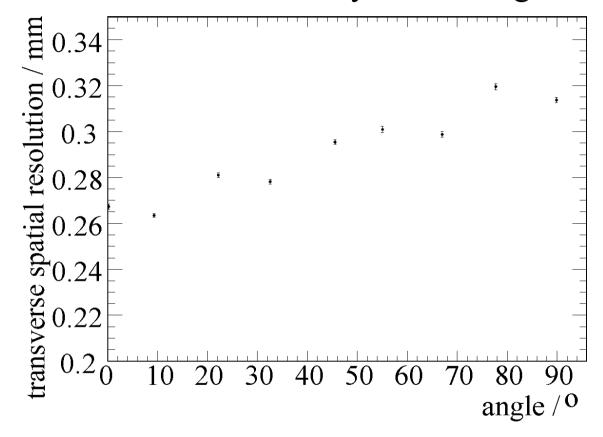






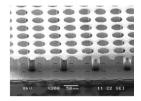
Very preliminary!!!

data was taken only 2 weeks ago



transverse spatial resolution in dependence on track inclination



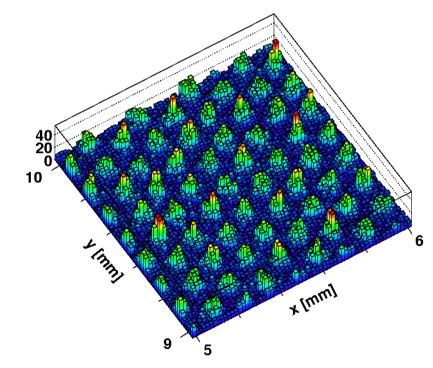


'Electron-tomography' of a GEM

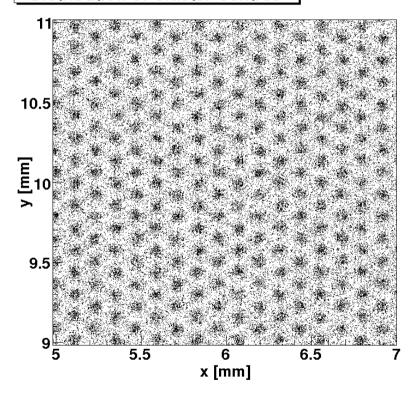


- 90Sr placed at a drift distance of 25 cm
- untriggered data taking
- reconstruction of hit positions

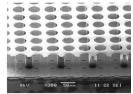




Distribution of Cluster Centres

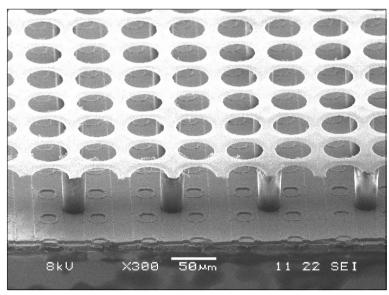


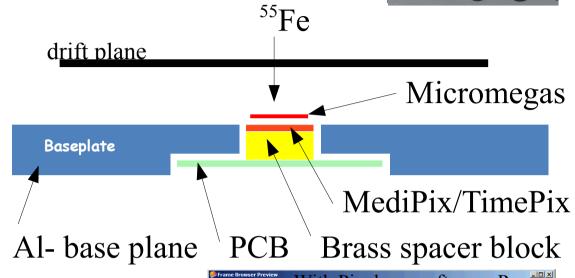




InGrid









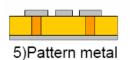


2)Spin SU-8







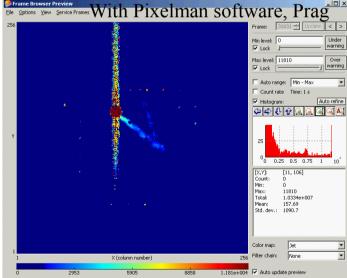




IMT Neuchatel: 15 or 20 μ m highly resistive aSi:H protection layer (~10¹¹ Ω ·cm)

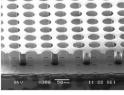
MESA+: InGrid





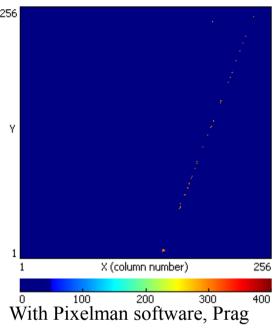
chip survives several 1000 discharges induced by Thorium





InGrid – some Event Pictures

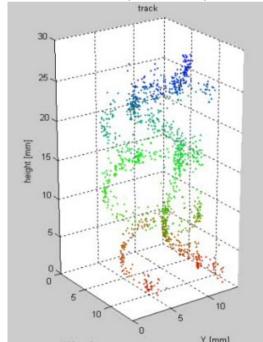


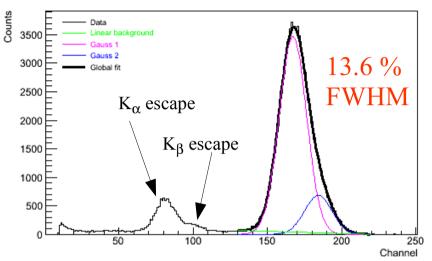


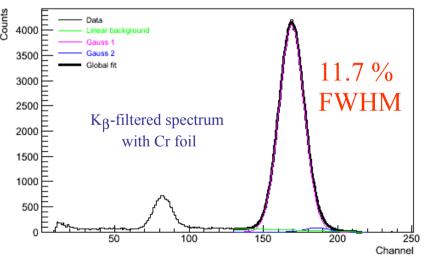


5 GeV negative hadron beam at CERN

 $-ArCO_2$ (70/30)



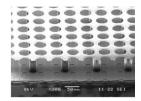




⁵⁵Fe spectrum in Ar:CH₄ 90-10

2 electrons from ⁹⁰Sr in B=0.2T







Gossip



Gas On Slimmed Silicon Pixel

drift plane

99 % chance to
have at least 1 e

Integrated Grid
(InGrid)

Slimmed Silicon Readout chip

50μm

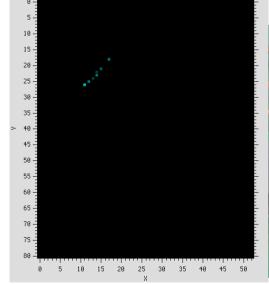
First prototype of GOSSIP on a PSI-46 (CMS Pixel FE chip) is working:

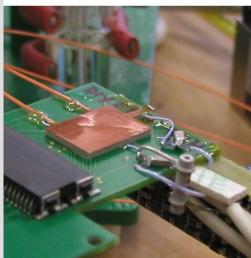
- 1.2 mm drift gap
- Grid signal used as trigger
- 30 µm layer of SiProt

Some advantages: gas versus Si

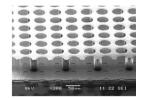
- it is light and cheap
 - gas amplification, no bias current
 - => low power & simple FE circuits
 - gas can be exchanged:
 - => no radiation damage of sensor
 - no temperature requirements
 - gas has a low ε_r : -> low capacitance

=> fast, low-noise, and low-power preamps







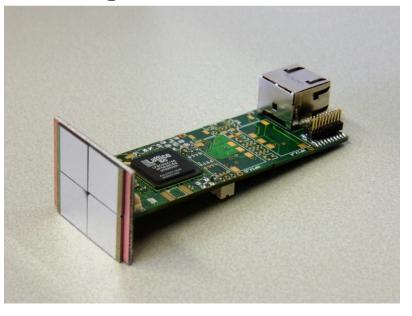


Gossip & InGrid



Gossip and InGrid based TPC face very similar challenges:

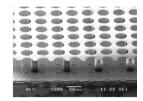
- spark protection solved by aSi:H layer
- aging must be tested/ under control
- diffusion limits max. drift length => test low diffusion gases (e.g. Ar:CF₄)
- enlarging surface (currently only 2 cm²)
- development of new readout chips



Development of new readout chips:

- GOSSIPO-2 at NIKHEF 16*16 Pixel, 0.13 μ m CMOS technology low noise σ_n =70e⁻ ENC low power consumption (2 μ W/channel) 1.8 ns time resolution
- TimePix-2 at CERN/NIKHEF/Bonn/... design will start soon





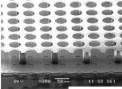
Conclusion & Outlook



- Development of micropattern gas detectors is a very active field.
- This is underlined by the formation of a new collaboration at
- CERN: RD51. Joining the forces to cover the needs of the community: test beams, irradiation facilities, electronics, industrialization,
- develop simulation tools,...
- Some very promising ideas have been made to work in the last years.
- Especially the readout with CMOS chips with very small pixels shows
- interesting results in a number of new applications.

New post-processing steps of readout chips are planned. e.g. pad enlarging, through-silicon-vias, ...





Modern Particle Identification



